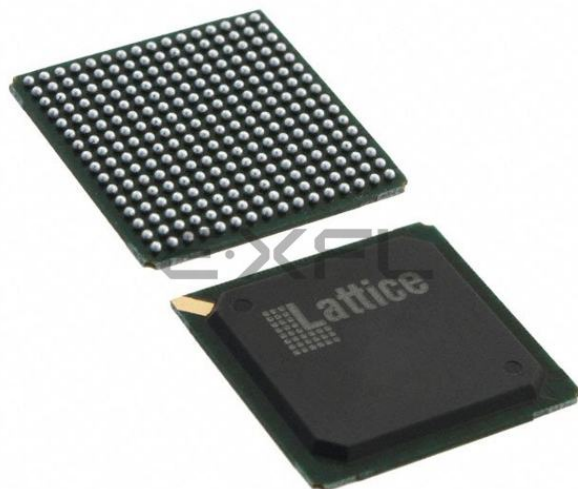




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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	750
Number of Logic Elements/Cells	6000
Total RAM Bits	56320
Number of I/O	190
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-6e-7f256c

Architecture Overview

Each LatticeECP2/M device contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM™ Embedded Block RAM (EBR) and rows of sys-DSP™ Digital Signal Processing blocks, as shown in Figure 2-1. In addition, the LatticeECP2M family contains SERDES Quads in one or more of the corners. Figure 2-2 shows the block diagram of ECP2M20 with one quad.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional Unit without RAM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM and ROM functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row.

The LatticeECP2/M devices contain one or more rows of sysMEM EBR blocks. sysMEM EBRs are large dedicated 18K fast memory blocks. Each sysMEM block can be configured in a variety of depths and widths of RAM or ROM. In addition, LatticeECP2/M devices contain up to two rows of DSP Blocks. Each DSP block has multipliers and adder/accumulators, which are the building blocks for complex signal processing capabilities.

The LatticeECP2M devices feature up to 16 embedded 3.125Gbps SERDES (Serializer / Deserializer) channels. Each SERDES channel contains independent 8b/10b encoding / decoding, polarity adjust and elastic buffer logic. Each group of four SERDES channels along with its Physical Coding Sub-layer (PCS) block, creates a quad. The functionality of the SERDES/PCS Quads can be controlled by memory cells set during device configuration or by registers that are addressable during device operation. The registers in every quad can be programmed by a soft IP interface, referred to as the SERDES Client Interface (SCI). These quads (up to four) are located at the corners of the devices.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O buffers. The sysI/O buffers of the LatticeECP2/M devices are arranged in eight banks, allowing the implementation of a wide variety of I/O standards. In addition, a separate I/O bank is provided for the programming interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. The PIC logic also includes pre-engineered support to aid in the implementation of high speed source synchronous standards such as SPI4.2, along with memory interfaces including DDR2.

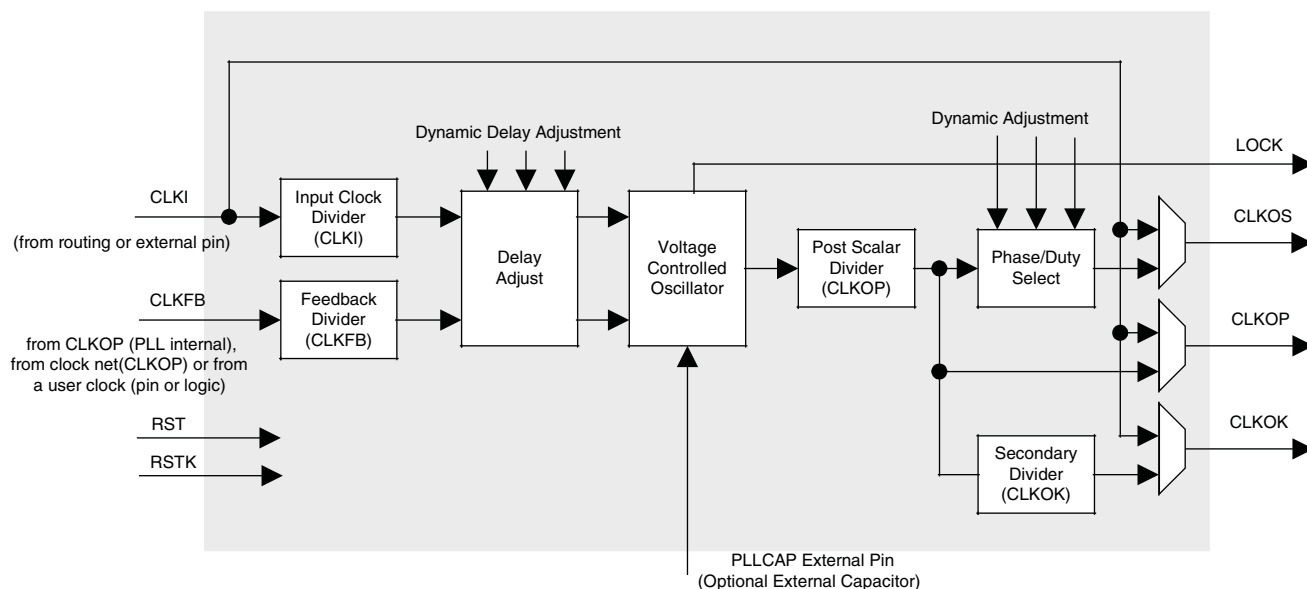
The LatticeECP2/M registers in PFU and sysI/O can be configured to be SET or RESET. After power up and the device is configured, it enters into user mode with these registers SET/RESET according to the configuration setting, allowing the device entering to a known state for predictable system function.

Other blocks provided include PLLs, DLLs and configuration functions. The LatticeECP2/M architecture provides two General PLLs (GPLL) and up to six Standard PLLs (SPLL) per device. In addition, each LatticeECP2/M family member provides two DLLs per device. The GPLLs and DLLs blocks are located in pairs at the end of the bottom-most EBR row; the DLL block is located towards the edge of the device. The SPLL blocks are located at the end of the other EBR/DSP rows.

The configuration block that supports features such as configuration bit-stream decryption, transparent updates and dual boot support is located toward the center of this EBR row. The Ball Grid Array (BGA) package devices in the LatticeECP2/M family supports a sysCONFIG™ port located in the corner between banks four and five, which allows for serial or parallel device configuration.

In addition, every device in the family has a JTAG port. This family also provides an on-chip oscillator. The LatticeECP2/M devices use 1.2V as their core voltage.

Figure 2-5. General Purpose PLL (GPLL) Diagram



Standard PLL (SPLL)

Some of the larger devices have two to six Standard PLLs (SPLLs). SPLLs have the same features as GPLLs but without delay adjustment capability. SPLLs also provide different parametric specifications. For more information, please see the list of additional technical documentation at the end of this data sheet.

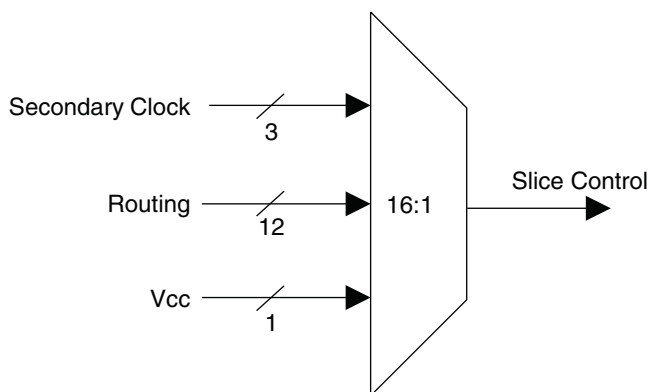
Table 2-4 provides a description of the signals in the GPLL and SPLL blocks.

Table 2-4. GPLL and SPLL Blocks Signal Descriptions

Signal	I/O	Description
CLKI	I	Clock input from external pin or routing
CLKFB	I	PLL feedback input from CLKOP (PLL internal), from clock net (CLKOP) or from a user clock (PIN or logic)
RST	I	"1" to reset PLL counters, VCO, charge pumps and M-dividers
RSTK	I	"1" to reset K-divider
CLKOS	O	PLL output clock to clock tree (phase shifted/duty cycle changed)
CLKOP	O	PLL output clock to clock tree (no phase shift)
CLKOK	O	PLL output to clock tree through secondary clock divider
LOCK	O	"1" indicates PLL LOCK to CLKI
DDAMODE ¹	I	Dynamic Delay Enable. "1": Pin control (dynamic), "0": Fuse Control (static)
DDAIZR ¹	I	Dynamic Delay Zero. "1": delay = 0, "0": delay = on
DDAILAG ¹	I	Dynamic Delay Lag/Lead. "1": Lead, "0": Lag
DDAIDEL[2:0] ¹	I	Dynamic Delay Input
DPA MODES	I	DPA (Dynamic Phase Adjust/Duty Cycle Select) mode
DPHASE [3:0]	I	DPA Phase Adjust inputs
DDDUTY [3:0]	—	DPA Duty Cycle Select inputs

1. These signals are not available in SPLL.

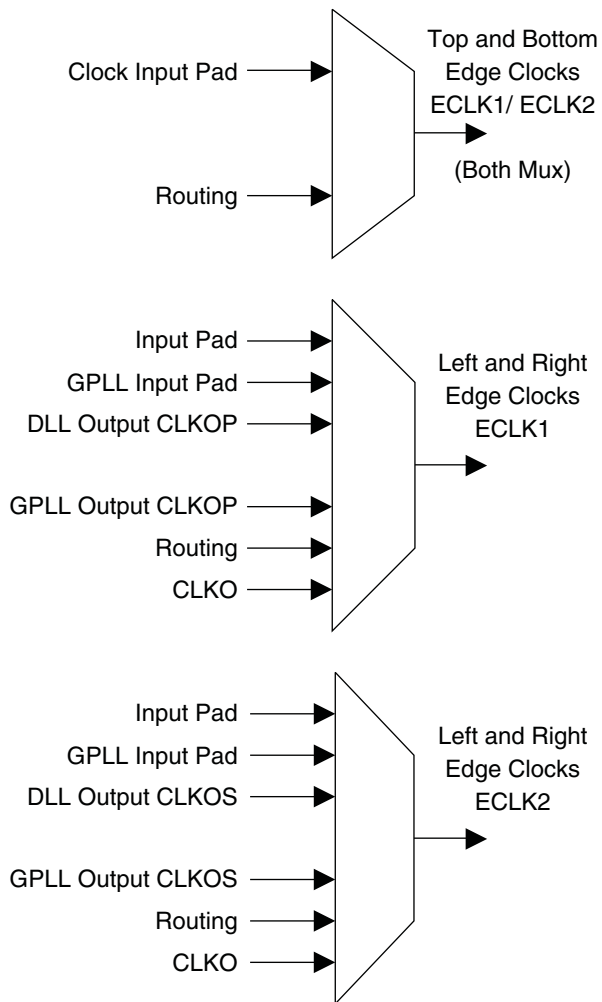
Figure 2-18. Slice0 through Slice2 Control Selection



Edge Clock Routing

LatticeECP2/M devices have a number of high-speed edge clocks that are intended for use with the PIOs in the implementation of high-speed interfaces. There are eight edge clocks per device: two edge clocks per edge. Different PLL and DLL outputs are routed to the two muxes on the left and right sides of the device. In addition, the CLKO signal (generated from the DLLDELA block) is routed to all the edge clock muxes on the left and right sides of the device. Figure 2-19 shows the selection muxes for these clocks.

Figure 2-19. Edge Clock Mux Connections



IEEE 1149.1-Compliant Boundary Scan Testability

All LatticeECP2/M devices have boundary scan cells that are accessed through an IEEE 1149.1 compliant Test Access Port (TAP). This allows functional testing of the circuit board, on which the device is mounted, through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS3.3, 2.5, 1.8, 1.5 and 1.2 standards.

For more details on boundary scan test, please see information regarding additional technical documentation at the end of this data sheet.

Device Configuration

All LatticeECP2/M devices contain two ports that can be used for device configuration. The Test Access Port (TAP), which supports bit-wide configuration, and the sysCONFIG port, support both byte-wide and serial configuration, including the standard SPI Flash interface. The TAP supports both the IEEE Standard 1149.1 Boundary Scan specification and the IEEE Standard 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six I/Os used as dedicated pins with the remainder used as dual-use pins. See TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#) for more information about using the dual-use pins as general purpose I/Os.

On power-up, the FPGA SRAM is ready to be configured using the selected sysCONFIG port. Once a configuration port is selected, it will remain active throughout that configuration cycle. The IEEE 1149.1 port can be activated any time after power-up by sending the appropriate command through the TAP port.

Enhanced Configuration Option

LatticeECP2/M devices have enhanced configuration features such as: decryption support, TransFR™ I/O and dual boot image support.

1. Decryption Support

LatticeECP2/M devices provide on-chip, One Time Programmable (OTP) non-volatile key storage to support decryption of a 128-bit AES encrypted bitstream, securing designs and deterring design piracy.

2. TransFR (Transparent Field Reconfiguration)

TransFR I/O (TFR) is a unique Lattice technology that allows users to update their logic in the field without interrupting system operation using a single ispVM® command. TransFR I/O allows I/O states to be frozen during device configuration. This allows the device to be field updated with a minimum of system disruption and downtime. See TN1087, [Minimizing System Interruption During Configuration Using TransFR Technology](#), for details.

3. Dual Boot Image Support

Dual boot images are supported for applications requiring reliable remote updates of configuration data for the system FPGA. After the system is running with a basic configuration, a new boot image can be downloaded remotely and stored in a separate location in the configuration storage device. Any time after the update the LatticeECP2/M can be re-booted from this new configuration file. If there is a problem, such as corrupt data during download or incorrect version number with this new boot image, the LatticeECP2/M device can revert back to the original backup configuration and try again. This all can be done without power cycling the system.

For more information about device configuration, please see the list of additional technical documentation at the end of this data sheet.

Soft Error Detect (SED) Support

LatticeECP2/M devices have dedicated logic to perform CRC checks. During configuration, the configuration data bitstream can be checked with the CRC logic block. In addition, the LatticeECP2 device can also be programmed

LatticeECP2M Supply Current (Standby)^{1, 2, 3, 4}
Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ⁵	Units
I_{CC}	Core Power Supply Current	ECP2M20	25	mA
		ECP2M35	50	mA
		ECP2M50	85	mA
		ECP2M70	100	mA
		ECP2M100	100	mA
I_{CCAUX}	Auxiliary Power Supply Current	ECP2M20	24	mA
		ECP2M35	24	mA
		ECP2M50	24	mA
		ECP2M70	24	mA
		ECP2M100	24	mA
I_{CCGPLL}	GPLL Power Supply Current (per GPLL)	All Devices	0.5	mA
I_{CCSPLL}	GPLL Power Supply Current (per SPLL)	All Devices	0.5	mA
I_{CCIO}	Bank Power Supply Current (Per Bank)	ECP2M20	2	mA
		ECP2M35	2	mA
		ECP2M50	2	mA
		ECP2M70	2	mA
		ECP2M100	2	mA
I_{CCJ}	V_{CCJ} Power Supply Current	All Devices	3	mA

1. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.

2. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.

3. Frequency 0MHz.

4. Pattern represents a "blank" configuration data file.

5. $T_J = 25^{\circ}\text{C}$, power supplies at normal voltage.

sys/I/O Recommended Operating Conditions

Standard	V _{CCIO}			V _{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVC MOS 3.3 ²	3.135	3.3	3.465	—	—	—
LVC MOS 2.5 ²	2.375	2.5	2.625	—	—	—
LVC MOS 1.8	1.71	1.8	1.89	—	—	—
LVC MOS 1.5	1.425	1.5	1.575	—	—	—
LVC MOS 1.2 ²	1.14	1.2	1.26	—	—	—
LVTTL ²	3.135	3.3	3.465	—	—	—
PCI	3.135	3.3	3.465	—	—	—
SSTL18 ² Class I, II	1.71	1.8	1.89	0.833	0.9	0.969
SSTL2 ² Class I, II	2.375	2.5	2.625	1.15	1.25	1.35
SSTL3 ² Class I, II	3.135	3.3	3.465	1.3	1.5	1.7
HSTL ² 15 Class I	1.425	1.5	1.575	0.68	0.75	0.9
HSTL ² 18 Class I, II	1.71	1.8	1.89	0.816	0.9	1.08
LVDS ²	2.375	2.5	2.625	—	—	—
MLVDS25 ¹	2.375	2.5	2.625	—	—	—
LVPECL33 ^{1,2}	3.135	3.3	3.465	—	—	—
BLVDS25 ^{1,2}	2.375	2.5	2.625	—	—	—
RSDS ^{1,2}	2.375	2.5	2.625	—	—	—
SSTL18D_I ² , II ²	1.71	1.8	1.89	—	—	—
SSTL25D_I ² , II ²	2.375	2.5	2.625	—	—	—
SSTL33D_I ² , II ²	3.135	3.3	3.465	—	—	—
HSTL15D_I ²	1.425	1.5	1.575	—	—	—
HSTL18D_I ² , II ²	1.71	1.8	1.89	—	—	—

1. Inputs on chip. Outputs are implemented with the addition of external resistors.

2. Input on this standard does not depend on the value of V_{CCIO}.

LatticeECP2/M External Switching Characteristics⁹

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
General I/O Pin Parameters (using Primary Clock without PLL) ¹									
t _{CO}	Clock to Output - PIO Output Register	LFE2-6	—	3.50	—	3.90	—	4.20	ns
		LFE2-12	—	3.50	—	3.90	—	4.20	ns
		LFE2-20	—	3.50	—	3.90	—	4.20	ns
		LFE2-35	—	3.50	—	3.90	—	4.20	ns
		LFE2-50	—	3.50	—	3.90	—	4.20	ns
		LFE2-70	—	3.70	—	4.10	—	4.40	ns
		LFE2M20	—	3.90	—	4.30	—	4.70	ns
		LFE2M35	—	3.90	—	4.30	—	4.70	ns
		LFE2M50	—	4.50	—	5.00	—	5.40	ns
		LFE2M70	—	4.50	—	5.00	—	5.40	ns
		LFE2M100	—	4.50	—	5.00	—	5.40	ns
t _{SU}	Clock to Data Setup - PIO Input Register	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
t _H	Clock to Data Hold - PIO Input Register	LFE2-6	1.40	—	1.70	—	1.90	—	ns
		LFE2-12	1.40	—	1.70	—	1.90	—	ns
		LFE2-20	1.40	—	1.70	—	1.90	—	ns
		LFE2-35	1.40	—	1.70	—	1.90	—	ns
		LFE2-50	1.40	—	1.70	—	1.90	—	ns
		LFE2-70	1.40	—	1.70	—	1.90	—	ns
		LFE2M20	1.40	—	1.70	—	1.90	—	ns
		LFE2M35	1.40	—	1.70	—	1.90	—	ns
		LFE2M50	1.80	—	2.10	—	2.30	—	ns
		LFE2M70	1.80	—	2.10	—	2.30	—	ns
		LFE2M100	1.80	—	2.10	—	2.30	—	ns

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t _{SUE}	Clock to Data Setup - PIO Input Register	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
t _{HE}	Clock to Data Hold - PIO Input Register	LFE2-6	0.90	—	1.10	—	1.30	—	ns
		LFE2-12	0.90	—	1.10	—	1.30	—	ns
		LFE2-20	0.90	—	1.10	—	1.30	—	ns
		LFE2-35	0.90	—	1.10	—	1.30	—	ns
		LFE2-50	0.90	—	1.10	—	1.30	—	ns
		LFE2-70	0.90	—	1.10	—	1.30	—	ns
		LFE2M20	0.90	—	1.10	—	1.30	—	ns
		LFE2M35	0.90	—	1.10	—	1.30	—	ns
		LFE2M50	1.20	—	1.40	—	1.60	—	ns
		LFE2M70	1.20	—	1.40	—	1.60	—	ns
		LFE2M100	1.20	—	1.40	—	1.60	—	ns
t _{SU_DELE}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.00	—	1.30	—	1.60	—	ns
		LFE2-12	1.00	—	1.30	—	1.60	—	ns
		LFE2-20	1.00	—	1.30	—	1.60	—	ns
		LFE2-35	1.00	—	1.30	—	1.60	—	ns
		LFE2-50	1.00	—	1.30	—	1.60	—	ns
		LFE2-70	1.00	—	1.30	—	1.60	—	ns
		LFE2M20	1.20	—	1.60	—	1.90	—	ns
		LFE2M35	1.20	—	1.60	—	1.90	—	ns
		LFE2M50	1.20	—	1.60	—	1.90	—	ns
		LFE2M70	1.20	—	1.60	—	1.90	—	ns
		LFE2M100	1.20	—	1.60	—	1.90	—	ns

LatticeECP2M Power Supply and NC (Cont.)

Signal	672 fpBGA	900 fpBGA
GND ¹	A13, A19, A2, A25, AA2, AA25, AB18, AB22, AB5, AB9, AE1, AE11, AE16, AE22, AE26, AE6, AF13, AF19, AF2, AF25, B1, B11, B16, B22, B26, B6, E18, E22, E5, E9, F2, F25, G11, G16, J22, J5, K11, K13, K14, K16, L10, L11, L16, L17, L2, L20, L25, L7, M13, M14, N10, N12, N13, N14, N15, N17, P10, P12, P13, P14, P15, P17, R13, R14, T10, T11, T16, T17, T2, T20, T25, T7, U11, U13, U14, U16, V22, V5, Y11, Y16	LFE2M50: A1, A13, A18, A24, A30, A7, AA14, AA15, AA16, AA17, AA24, AA27, AA4, AB24, AB7, AD12, AD19, AD27, AE22, AE27, AE4, AE9, AF14, AF17, AF25, AF6, AJ10, AJ21, AJ27, AJ4, AK1, AK13, AK18, AK24, AK30, AK7, B10, B21, B27, B4, D25, D6, E14, E17, F22, F27, F4, F9, G12, G19, J24, J7, K14, K15, K16, K17, K27, K4, L14, L15, L16, L17, M23, M8, N14, N15, N16, N17, N27, N4, P11, P13, P14, P15, P16, P17, P18, P20, R10, R11, R13, R14, R15, R16, R17, R18, R20, R21, R24, R7, T10, T11, T13, T14, T15, T16, T17, T18, T20, T21, T24, T7, U11, U13, U14, U15, U16, U17, U18, U20, V14, V15, V16, V17, V27, V4, W23, W8, Y14, Y15, Y16, Y17 LFE2M70/LFE2M100: A1, A13, A18, A24, A30, A7, AA14, AA15, AA16, AA17, AA24, AA27, AA4, AB24, AB7, AD12, AD19, AD27, AE22, AE27, AE4, AE9, AF14, AF17, AF25, AF6, AJ10, AJ21, AJ27, AJ4, AK1, AK13, AK18, AK24, AK30, AK7, B10, B21, B27, B4, D25, D6, E14, E17, F22, F27, F4, F9, G12, G19, J24, J7, K14, K15, K16, K17, K27, K4, L14, L15, L16, L17, M23, M8, N14, N15, N16, N17, N27, N4, P11, P13, P14, P15, P16, P17, P18, P20, R10, R11, R13, R14, R15, R16, R17, R18, R20, R21, R24, R7, T10, T11, T13, T14, T15, T16, T17, T18, T20, T21, T24, T7, U11, U13, U14, U15, U16, U17, U18, U20, V14, V15, V16, V17, V27, V4, W23, W8, Y14, Y15, Y16, Y17
NC ²	LFE2M35: AB3, AB4, AC1, AC2, AD15, AD18, AD20, AD23, AE13, AE25, AF16, AF22, B4, B5, C26, D20, D21, D22, D23, D24, D25, D26, E20, E21, E25, E26, F20, G20, K10, K17, R4, U10, U23, V10, W7, N7, V7 LFE2M50: AB3, AB4, AC1, AC2, B4, B5, C26, D20, D21, D22, D23, D24, D25, D26, E20, E21, E25, E26, F20, G20, K10, K17, R4, U10, U23, V10, W7, AB21, AC20, AC21, AC22, AC23, AC25, AD26, W20	LFE2M50: G5, G4, K7, K8, E1, F2, F1, G3, G2, G1, L9, L7, K6, K5, L8, L6, AA1, AA2, Y3, AB1, Y9, Y8, Y7, AA7, AB2, AB3, AA5, AA6, AB4, AB5, AA8, AA9, AJ1, AK4, AH6, AH3, AH11, AH8, AK10, AJ13, AB26, AB27, Y24, Y25, AA29, Y28, Y30, Y29, W22, V22, Y27, Y26, W30, W29, W25, W26, L24, L23, D30, D29, K24, K25, J27, K26, J26, H26, H27, G26, H23, H24, D28, E28, J18, J19, H17, J17, F18, F17, B13, A10, C8, C11, C3, C6, A4, B1, AA26, AB11, AB12, AB13, AB14, AB15, AB16, AB17, AB19, AB20, AB21, AC11, AC21, AC22, AD21, AD22, AE23, AF20, AF23, AG23, AG26, F20, F23, G10, G20, G21, H19, H20, H21, H22, J20, J21, R9, U22, W9 LFE2M70/LFE2M100: AA26, AB10, AB11, AB12, AB13, AB14, AB15, AB16, AB17, AB19, AB20, AB21, AB9, AC10, AC11, AC21, AC22, AC8, AC9, AD21, AD22, AD4, AD5, AD6, AD7, AD8, AE23, AE5, AE6, AE7, AF20, AF23, AF5, AG23, AG26, D10, E10, E11, F10, F20, F23, F8, G10, G20, G21, G7, G8, G9, H19, H20, H21, H22, H6, H8, H9, J10, J20, J21, J9, K9, R9, U22, W9

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. For package migration across device densities, the designer must comprehend the package pin requirements for the SERDES blocks. Specifically, the SERDES power pins of the largest density device must be accounted to accommodate migration to other smaller devices using the same package. Please refer to TN1160, [LatticeECP2/M Density Migration](#) for more details.

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
G17	PR13B	2	RDQ14	C	PR15B	2	RDQ16	C
F19	PR13A	2	RDQ14	T	PR15A	2	RDQ16	T
E20	PR12B	2	RDQ14	C (LVDS)*	PR14B	2	RDQ16	C (LVDS)*
D20	PR12A	2	RDQ14	T (LVDS)*	PR14A	2	RDQ16	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO	2		
F18	PR11B	2	RDQ14	C	PR13B	2	RDQ16	C
F16	PR11A	2	RDQ14	T	PR13A	2	RDQ16	T
C21	PR10B	2	RDQ14	C (LVDS)*	PR12B	2	RDQ16	C (LVDS)*
C22	PR10A	2	RDQ14	T (LVDS)*	PR12A	2	RDQ16	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO	2		
GNDIO	GNDIO2	-			GNDIO2	-		
D19	PR2B	2	VREF2_2/RDQ6	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*
E19	PR2A	2	VREF1_2/RDQ6	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*
B21	PT73B	1	VREF2_1	C	PT82B	1	VREF2_1	C
GNDIO	GNDIO1	-			GNDIO1	-		
B22	PT73A	1	VREF1_1	T	PT82A	1	VREF1_1	T
C20	PT72B	1		C	PT81B	1		C
C19	PT72A	1		T	PT81A	1		T
D18	PT71B	1		C	PT80B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
E18	PT71A	1		T	PT80A	1		T
B20	PT70B	1		C	PT79B	1		C
A19	PT70A	1		T	PT79A	1		T
D17	PT69B	1		C	PT78B	1		C
C18	PT69A	1		T	PT78A	1		T
A21	PT68B	1		C	PT77B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
A20	PT68A	1		T	PT77A	1		T
A18	PT67B	1		C	PT76B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
B18	PT67A	1		T	PT76A	1		T
G16	PT66B	1		C	PT75B	1		C
G15	PT66A	1		T	PT75A	1		T
D16	PT65B	1		C	PT74B	1		C
E16	PT65A	1		T	PT74A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
VCCIO	VCCIO1	1			VCCIO	1		
C17	PT55B	1		C	PT64B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
C16	PT55A	1		T	PT64A	1		T
B17	PT54B	1		C	PT63B	1		C
B16	PT54A	1		T	PT63A	1		T
A17	PT53B	1		C	PT62B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
A16	PT53A	1		T	PT62A	1		T
C15	PT52B	1		C	PT61B	1		C

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
W5	PL38B	6	LDQ42	C (LVDS)*	PL52B	6	LDQ56	C (LVDS)*	
AC1	PL39A	6	LDQ42	T	PL53A	6	LDQ56	T	
AD1	PL39B	6	LDQ42	C	PL53B	6	LDQ56	C	
VCCIO	VCCIO6	6			VCCIO6	6			
Y6	PL40A	6	LDQ42	T (LVDS)*	PL54A	6	LDQ56	T (LVDS)*	
Y5	PL40B	6	LDQ42	C (LVDS)*	PL54B	6	LDQ56	C (LVDS)*	
AE2	PL41A	6	LDQ42	T	PL55A	6	LDQ56	T	
AD2	PL41B	6	LDQ42	C	PL55B	6	LDQ56	C	
GND	GNDIO6	-			GNDIO6	-			
AB3	PL42A	6	LDQS42	T (LVDS)*	PL56A	6	LDQS56	T (LVDS)*	
AB2	PL42B	6	LDQ42	C (LVDS)*	PL56B	6	LDQ56	C (LVDS)*	
W7	PL43A	6	LDQ42	T	PL57A	6	LDQ56	T	
VCCIO	VCCIO6	6			VCCIO6	6			
W8	PL43B	6	LDQ42	C	PL57B	6	LDQ56	C	
Y7	PL44A	6	LDQ42	T (LVDS)*	PL58A	6	LDQ56	T (LVDS)*	
Y8	PL44B	6	LDQ42	C (LVDS)*	PL58B	6	LDQ56	C (LVDS)*	
AC2	PL45A	6	LDQ42	T	PL59A	6	LDQ56	T	
GND	GNDIO6	-			GNDIO6	-			
AD3	PL45B	6	LDQ42	C	PL59B	6	LDQ56	C	
AC3	TCK	-			TCK	-			
AA8	TDI	-			TDI	-			
AB4	TMS	-			TMS	-			
AA5	TDO	-			TDO	-			
AB5	VCCJ	-			VCCJ	-			
AE3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T	
AF3	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C	
AC4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T	
AD4	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C	
AE4	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T	
AF4	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			
V9	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T	
W9	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C	
GND	GNDIO5	-			GNDIO5	-			
AA6	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T	
AB6	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C	
AC5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T	
AD5	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C	
AA7	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T	
AB7	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AE5	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T	
AF5	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C	
AC7	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T	
AD7	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A2	GND	-			GND	-		
A25	GND	-			GND	-		
AA18	GND	-			GND	-		
AA24	GND	-			GND	-		
AA3	GND	-			GND	-		
AA9	GND	-			GND	-		
AD11	GND	-			GND	-		
AD16	GND	-			GND	-		
AD21	GND	-			GND	-		
AD6	GND	-			GND	-		
AE1	GND	-			GND	-		
AE26	GND	-			GND	-		
AF2	GND	-			GND	-		
AF25	GND	-			GND	-		
B1	GND	-			GND	-		
B26	GND	-			GND	-		
C11	GND	-			GND	-		
C16	GND	-			GND	-		
C21	GND	-			GND	-		
C6	GND	-			GND	-		
F18	GND	-			GND	-		
F24	GND	-			GND	-		
F3	GND	-			GND	-		
F9	GND	-			GND	-		
J13	GND	-			GND	-		
J14	GND	-			GND	-		
J21	GND	-			GND	-		
J6	GND	-			GND	-		
K10	GND	-			GND	-		
K11	GND	-			GND	-		
K13	GND	-			GND	-		
K14	GND	-			GND	-		
K16	GND	-			GND	-		
K17	GND	-			GND	-		
L10	GND	-			GND	-		
L11	GND	-			GND	-		
L16	GND	-			GND	-		
L17	GND	-			GND	-		
L24	GND	-			GND	-		
L3	GND	-			GND	-		
M13	GND	-			GND	-		
M14	GND	-			GND	-		
N10	GND	-			GND	-		
N12	GND	-			GND	-		
N13	GND	-			GND	-		
N14	GND	-			GND	-		

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO5	-			GNDIO5	-		
W10	PB20A	5	BDQ24	T	PB29A	5	BDQ33	T
Y10	PB20B	5	BDQ24	C	PB29B	5	BDQ33	C
W11	PB21A	5	BDQ24	T	PB30A	5	BDQ33	T
AA10	PB21B	5	BDQ24	C	PB30B	5	BDQ33	C
AC8	PB22A	5	BDQ24	T	PB31A	5	BDQ33	T
AD8	PB22B	5	BDQ24	C	PB31B	5	BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
AB8	PB23A	5	BDQ24	T	PB32A	5	BDQ33	T
AB10	PB23B	5	BDQ24	C	PB32B	5	BDQ33	C
GND	GNDIO5	-			GNDIO5	-		
AE6	PB24A	5	BDQS24	T	PB33A	5	BDQS33	T
AF6	PB24B	5	BDQ24	C	PB33B	5	BDQ33	C
AA11	PB25A	5	BDQ24	T	PB34A	5	BDQ33	T
AC9	PB25B	5	BDQ24	C	PB34B	5	BDQ33	C
AB9	PB26A	5	BDQ24	T	PB35A	5	BDQ33	T
AD9	PB26B	5	BDQ24	C	PB35B	5	BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
Y11	PB27A	5	BDQ24	T	PB36A	5	BDQ33	T
AB11	PB27B	5	BDQ24	C	PB36B	5	BDQ33	C
AE7	PB28A	5	BDQ24	T	PB37A	5	BDQ33	T
AF7	PB28B	5	BDQ24	C	PB37B	5	BDQ33	C
GND	GNDIO5	-			GNDIO5	-		
AC10	PB29A	5	BDQ33	T	PB38A	5	BDQ42	T
AD10	PB29B	5	BDQ33	C	PB38B	5	BDQ42	C
AA12	PB30A	5	BDQ33	T	PB39A	5	BDQ42	T
W12	PB30B	5	BDQ33	C	PB39B	5	BDQ42	C
AB12	PB31A	5	BDQ33	T	PB40A	5	BDQ42	T
VCCIO	VCCIO5	5			VCCIO5	5		
Y12	PB31B	5	BDQ33	C	PB40B	5	BDQ42	C
AD12	PB32A	5	BDQ33	T	PB41A	5	BDQ42	T
AC12	PB32B	5	BDQ33	C	PB41B	5	BDQ42	C
AC13	PB33A	5	BDQS33	T	PB42A	5	BDQS42	T
GND	GNDIO5	-			GNDIO5	-		
AA13	PB33B	5	BDQ33	C	PB42B	5	BDQ42	C
AD13	PB34A	5	BDQ33	T	PB43A	5	BDQ42	T
AC14	PB34B	5	BDQ33	C	PB43B	5	BDQ42	C
AE8	PB35A	5	BDQ33	T	PB44A	5	BDQ42	T
VCCIO	VCCIO5	5			VCCIO5	5		
AF8	PB35B	5	BDQ33	C	PB44B	5	BDQ42	C
AB15	PB36A	5	BDQ33	T	PB45A	5	BDQ42	T
Y13	PB36B	5	BDQ33	C	PB45B	5	BDQ42	C
AE9	PB37A	5	BDQ33	T	PB46A	5	BDQ42	T
GND	GNDIO5	-			GNDIO5	-		
AF9	PB37B	5	BDQ33	C	PB46B	5	BDQ42	C
W13	PB38A	5	BDQ42	T	PB47A	5	BDQ51	T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AA14	PB38B	5	BDQ42	C	PB47B	5	BDQ51	C	
AE10	PB39A	5	BDQ42	T	PB48A	5	BDQ51	T	
AF10	PB39B	5	BDQ42	C	PB48B	5	BDQ51	C	
W14	PB40A	5	BDQ42	T	PB49A	5	BDQ51	T	
AB13	PB40B	5	BDQ42	C	PB49B	5	BDQ51	C	
VCCIO	VCCIO5	5			VCCIO5	5			
Y14	PB41A	5	BDQ42	T	PB50A	5	BDQ51	T	
AB14	PB41B	5	BDQ42	C	PB50B	5	BDQ51	C	
GND	GNDIO5	-			GNDIO5	-			
AE11	PB42A	5	BDQS42	T	PB51A	5	BDQS51	T	
AF11	PB42B	5	BDQ42	C	PB51B	5	BDQ51	C	
AD14	PB43A	5	BDQ42	T	PB52A	5	BDQ51	T	
AA15	PB43B	5	BDQ42	C	PB52B	5	BDQ51	C	
AE12	PB44A	5	PCLKT5_0/BDQ42	T	PB53A	5	PCLKT5_0/BDQ51	T	
AF12	PB44B	5	PCLKC5_0/BDQ42	C	PB53B	5	PCLKC5_0/BDQ51	C	
VCCIO	VCCIO5	5			VCCIO5	5			
GND	GNDIO5	-			GNDIO5	-			
AD15	PB49A	4	PCLKT4_0/BDQ51	T	PB58A	4	PCLKT4_0/BDQ60	T	
VCCIO	VCCIO4	4			VCCIO4	4			
AC15	PB49B	4	PCLKC4_0/BDQ51	C	PB58B	4	PCLKC4_0/BDQ60	C	
AE13	PB50A	4	BDQ51	T	PB59A	4	BDQ60	T	
AF13	PB50B	4	BDQ51	C	PB59B	4	BDQ60	C	
AB17	PB51A	4	BDQS51	T	PB60A	4	BDQS60	T	
GND	GNDIO4	-			GNDIO4	-			
Y15	PB51B	4	BDQ51	C	PB60B	4	BDQ60	C	
AE14	PB52A	4	BDQ51	T	PB61A	4	BDQ60	T	
AF14	PB52B	4	BDQ51	C	PB61B	4	BDQ60	C	
AA16	PB53A	4	BDQ51	T	PB62A	4	BDQ60	T	
VCCIO	VCCIO4	4			VCCIO4	4			
W15	PB53B	4	BDQ51	C	PB62B	4	BDQ60	C	
AC17	PB54A	4	BDQ51	T	PB63A	4	BDQ60	T	
AB16	PB54B	4	BDQ51	C	PB63B	4	BDQ60	C	
AE15	PB55A	4	BDQ51	T	PB64A	4	BDQ60	T	
GND	GNDIO4	-			GNDIO4	-			
AF15	PB55B	4	BDQ51	C	PB64B	4	BDQ60	C	
AE16	PB56A	4	BDQ60	T	PB65A	4	BDQ69	T	
AF16	PB56B	4	BDQ60	C	PB65B	4	BDQ69	C	
Y16	PB57A	4	BDQ60	T	PB66A	4	BDQ69	T	
AB18	PB57B	4	BDQ60	C	PB66B	4	BDQ69	C	
AD17	PB58A	4	BDQ60	T	PB67A	4	BDQ69	T	
AD18	PB58B	4	BDQ60	C	PB67B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AC18	PB59A	4	BDQ60	T	PB68A	4	BDQ69	T	
AD19	PB59B	4	BDQ60	C	PB68B	4	BDQ69	C	
GND	GNDIO4	-			GNDIO4	-			
AC19	PB60A	4	BDQS60	T	PB69A	4	BDQS69	T	

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A7	PT35B	0		C	PT44B	0		C
B7	PT35A	0		T	PT44A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
F12	PT34B	0		C	PT43B	0		C
D10	PT34A	0		T	PT43A	0		T
H11	PT33B	0		C	PT42B	0		C
G11	PT33A	0		T	PT42A	0		T
GND	GNDIO0	-			GNDIO0	-		
A6	PT32B	0		C	PT41B	0		C
B6	PT32A	0		T	PT41A	0		T
D8	PT31B	0		C	PT40B	0		C
C8	PT31A	0		T	PT40A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
F11	PT30B	0		C	PT39B	0		C
E10	PT30A	0		T	PT39A	0		T
E9	PT29B	0		C	PT38B	0		C
D9	PT29A	0		T	PT38A	0		T
G10	PT28B	0		C	PT37B	0		C
GND	GNDIO0	-			GNDIO0	-		
H10	PT28A	0		T	PT37A	0		T
A5	PT27B	0		C	PT36B	0		C
B5	PT27A	0		T	PT36A	0		T
C7	PT26B	0		C	PT35B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
D7	PT26A	0		T	PT35A	0		T
E8	PT25B	0		C	PT34B	0		C
F10	PT25A	0		T	PT34A	0		T
F8	PT24B	0		C	PT33B	0		C
H9	PT24A	0		T	PT33A	0		T
C5	PT23B	0		C	PT32B	0		C
GND	GNDIO0	-			GNDIO0	-		
D5	PT23A	0		T	PT32A	0		T
B4	PT22B	0			PT31B	0		
VCCIO	VCCIO0	0			VCCIO0	0		
GND	GNDIO0	-			GNDIO0	-		
VCCIO	VCCIO0	0			VCCIO0	0		
GND	GNDIO0	-			GNDIO0	-		
VCCIO	VCCIO0	0			VCCIO0	0		
C4	PT10B	0		C	PT10B	0		C
GND	GNDIO0	-			GNDIO0	-		
C3	PT10A	0		T	PT10A	0		T
A4	PT9B	0		C	PT9B	0		C
A3	PT9A	0		T	PT9A	0		T
B3	PT8B	0		C	PT8B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
B2	PT8A	0		T	PT8A	0		T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N15	GND	-			GND	-		
N17	GND	-			GND	-		
P10	GND	-			GND	-		
P12	GND	-			GND	-		
P13	GND	-			GND	-		
P14	GND	-			GND	-		
P15	GND	-			GND	-		
P17	GND	-			GND	-		
R13	GND	-			GND	-		
R14	GND	-			GND	-		
T10	GND	-			GND	-		
T11	GND	-			GND	-		
T16	GND	-			GND	-		
T17	GND	-			GND	-		
T24	GND	-			GND	-		
T3	GND	-			GND	-		
U10	GND	-			GND	-		
U11	GND	-			GND	-		
U13	GND	-			GND	-		
U14	GND	-			GND	-		
U16	GND	-			GND	-		
U17	GND	-			GND	-		
V13	GND	-			GND	-		
V14	GND	-			GND	-		
V21	GND	-			GND	-		
V6	GND	-			GND	-		
M3	NC	-			NC	-		
N6	NC	-			NC	-		
P24	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
T7	PB22A	4	PCLKT4_0/BDQ24	T	PB40A	4	PCLKT4_0/BDQ42	T
VCCIO	VCCIO4	4			VCCIO4	4		
T8	PB22B	4	PCLKC4_0/BDQ24	C	PB40B	4	PCLKC4_0/BDQ42	C
L7	PB23A	4	VREF2_4/BDQ24	T	PB41A	4	VREF2_4/BDQ42	T
L8	PB23B	4	VREF1_4/BDQ24	C	PB41B	4	VREF1_4/BDQ42	C
GNDIO	GNDIO4	-			GNDIO4	-		
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
P8	PB29A	4	BDQ33	T	PB47A	4	BDQ51	T
N8	PB29B	4	BDQ33	C	PB47B	4	BDQ51	C
R7	PB30A	4	BDQ33	T	PB48A	4	BDQ51	T
R8	PB30B	4	BDQ33	C	PB48B	4	BDQ51	C
N7	PB31A	4	BDQ33	T	PB49A	4	BDQ51	T
M8	PB31B	4	BDQ33	C	PB49B	4	BDQ51	C
VCCIO	VCCIO4	4			VCCIO4	4		
R9	PB32A	4	BDQ33	T	PB50A	4	BDQ51	T
T9	PB32B	4	BDQ33	C	PB50B	4	BDQ51	C
GNDIO	GNDIO4	-			GNDIO4	-		
T10	PB33A	4	BDQS33	T	PB51A	4	BDQS51	T
R10	PB33B	4	BDQ33	C	PB51B	4	BDQ51	C
N9	PB34A	4	BDQ33	T	PB52A	4	BDQ51	T
P10	PB34B	4	BDQ33	C	PB52B	4	BDQ51	C
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
L9	PB47A	4	BDQ51	T	PB65A	4	BDQ69	T
M9	PB47B	4	BDQ51	C	PB65B	4	BDQ69	C
T11	PB49A	4	BDQ51	T	PB67A	4	BDQ69	T
R11	PB49B	4	BDQ51	C	PB67B	4	BDQ69	C
VCCIO	VCCIO4	4			VCCIO4	4		
T12	PB50A	4	BDQ51	T	PB68A	4	BDQ69	T
T13	PB50B	4	BDQ51	C	PB68B	4	BDQ69	C
GNDIO	GNDIO4	-			GNDIO4	-		
P11	PB51A	4	BDQS51	T	PB69A	4	BDQS69	T
N10	PB51B	4	BDQ51	C	PB69B	4	BDQ69	C
T14	PB52A	4	BDQ51	T	PB70A	4	BDQ69	T
R13	PB52B	4	BDQ51	C	PB70B	4	BDQ69	C
R15	PB53A	4	BDQ51	T	PB71A	4	BDQ69	T
R16	PB53B	4	BDQ51	C	PB71B	4	BDQ69	C
VCCIO	VCCIO4	4			VCCIO4	4		
R14	PB54A	4	BDQ51	T	PB72A	4	BDQ69	T
P15	PB54B	4	BDQ51	C	PB72B	4	BDQ69	C
P16	PB55A	4	BDQ51	T	PB73A	4	BDQ69	T
P14	PB55B	4	BDQ51	C	PB73B	4	BDQ69	C
GNDIO	GNDIO4	-			GNDIO4	-		
L11	CFG2	8			CFG2	8		
L10	CFG1	8			CFG1	8		
P13	CFG0	8			CFG0	8		
N12	PROGRAMN	8			PROGRAMN	8		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
R21	VCC	-			VCC	-		
R22	VCC	-			VCC	-		
T14	VCC	-			VCC	-		
T21	VCC	-			VCC	-		
U14	VCC	-			VCC	-		
U21	VCC	-			VCC	-		
V14	VCC	-			VCC	-		
V21	VCC	-			VCC	-		
W14	VCC	-			VCC	-		
W21	VCC	-			VCC	-		
Y13	VCC	-			VCC	-		
Y14	VCC	-			VCC	-		
Y21	VCC	-			VCC	-		
Y22	VCC	-			VCC	-		
C12	VCCIO0	0			VCCIO0	0		
C16	VCCIO0	0			VCCIO0	0		
E14	VCCIO0	0			VCCIO0	0		
H12	VCCIO0	0			VCCIO0	0		
H16	VCCIO0	0			VCCIO0	0		
M14	VCCIO0	0			VCCIO0	0		
M15	VCCIO0	0			VCCIO0	0		
C19	VCCIO1	1			VCCIO1	1		
C23	VCCIO1	1			VCCIO1	1		
E21	VCCIO1	1			VCCIO1	1		
H19	VCCIO1	1			VCCIO1	1		
H23	VCCIO1	1			VCCIO1	1		
M20	VCCIO1	1			VCCIO1	1		
M21	VCCIO1	1			VCCIO1	1		
G32	VCCIO2	2			VCCIO2	2		
K28	VCCIO2	2			VCCIO2	2		
K32	VCCIO2	2			VCCIO2	2		
N27	VCCIO2	2			VCCIO2	2		
N32	VCCIO2	2			VCCIO2	2		
P23	VCCIO2	2			VCCIO2	2		
R23	VCCIO2	2			VCCIO2	2		
T27	VCCIO2	2			VCCIO2	2		
T32	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
AB27	VCCIO3	3			VCCIO3	3		
AB32	VCCIO3	3			VCCIO3	3		
AE28	VCCIO3	3			VCCIO3	3		
AE32	VCCIO3	3			VCCIO3	3		
AH32	VCCIO3	3			VCCIO3	3		
W27	VCCIO3	3			VCCIO3	3		
W32	VCCIO3	3			VCCIO3	3		
Y23	VCCIO3	3			VCCIO3	3		
AC20	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
AG19	VCCIO4	4			VCCIO4	4		

LatticeECP2M Standard Series Devices, Lead-Free Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5FN484C	304	1.2V	-5	Lead-Free fpBGA	484	COM	20
LFE2M20E-6FN484C	304	1.2V	-6	Lead-Free fpBGA	484	COM	20
LFE2M20E-7FN484C	304	1.2V	-7	Lead-Free fpBGA	484	COM	20
LFE2M20E-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	COM	20
LFE2M20E-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	COM	20
LFE2M20E-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	COM	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5FN672C	410	1.2V	-5	Lead-Free fpBGA	672	COM	35
LFE2M35E-6FN672C	410	1.2V	-6	Lead-Free fpBGA	672	COM	35
LFE2M35E-7FN672C	410	1.2V	-7	Lead-Free fpBGA	672	COM	35
LFE2M35E-5FN484C	303	1.2V	-5	Lead-Free fpBGA	484	COM	35
LFE2M35E-6FN484C	303	1.2V	-6	Lead-Free fpBGA	484	COM	35
LFE2M35E-7FN484C	303	1.2V	-7	Lead-Free fpBGA	484	COM	35
LFE2M35E-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	COM	35
LFE2M35E-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	COM	35
LFE2M35E-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5FN900C	410	1.2V	-5	Lead-Free fpBGA	900	COM	50
LFE2M50E-6FN900C	410	1.2V	-6	Lead-Free fpBGA	900	COM	50
LFE2M50E-7FN900C	410	1.2V	-7	Lead-Free fpBGA	900	COM	50
LFE2M50E-5FN672C	372	1.2V	-5	Lead-Free fpBGA	672	COM	50
LFE2M50E-6FN672C	372	1.2V	-6	Lead-Free fpBGA	672	COM	50
LFE2M50E-7FN672C	372	1.2V	-7	Lead-Free fpBGA	672	COM	50
LFE2M50E-5FN484C	270	1.2V	-5	Lead-Free fpBGA	484	COM	50
LFE2M50E-6FN484C	270	1.2V	-6	Lead-Free fpBGA	484	COM	50
LFE2M50E-7FN484C	270	1.2V	-7	Lead-Free fpBGA	484	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5FN1152C	436	1.2V	-5	Lead-Free fpBGA	1152	COM	70
LFE2M70E-6FN1152C	436	1.2V	-6	Lead-Free fpBGA	1152	COM	70
LFE2M70E-7FN1152C	436	1.2V	-7	Lead-Free fpBGA	1152	COM	70
LFE2M70E-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	COM	70
LFE2M70E-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	COM	70
LFE2M70E-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	COM	70

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100SE-5FN1152C	520	1.2V	-5	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-6FN1152C	520	1.2V	-6	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-7FN1152C	520	1.2V	-7	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	Com	100
LFE2M100SE-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	Com	100
LFE2M100SE-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	Com	100